

2SD1970

Silicon NPN Epitaxial

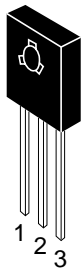
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Application

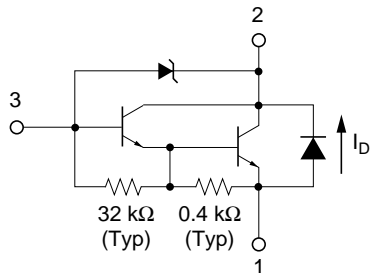
Low frequency power amplifier

Outline

TO-126 MOD



- 1. Emitter
- 2. Collector
- 3. Base



2SD1970

Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Rated	Unit
Collector to base voltage	V_{CBO}	24	V
Collector to emitter voltage	V_{CEO}	24	V
Emitter to base voltage	V_{EBO}	7	V
Collector current	I_C	2	A
Collector peak current	$I_{C(peak)}$	4	A
C to E diode forward current	I_D	2	A
Collector power dissipation	P_C^{*1}	10	W
Junction temperature	T_j	150	°C
Storage temperature	T_{stg}	-55 to +150	°C

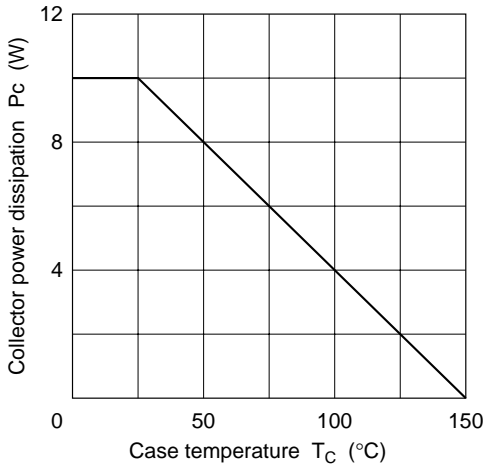
Note: 1. Value at $T_C = 25^\circ\text{C}$.

Electrical Characteristics (Ta = 25°C)

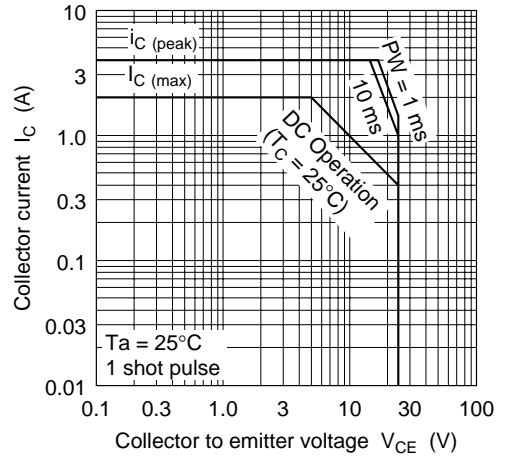
Item	Symbol	Min	Typ	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CEO}$	24	—	32	V	$I_C = 1\text{ mA}, I_E = 0$
Collector to emitter sustain voltage	$V_{CEO(sus)}$	25	—	33	V	$I_C = 1\text{ A}, L = 20\text{ mH}, R_{BE} = \infty$
Emitter to base breakdown voltage	$V_{(BR)EBO}$	7	—	—	V	$I_E = 5\text{ mA}, I_C = 0$
Collector cutoff current	I_{CBO}	—	—	1	μA	$V_{CB} = 20\text{ V}, I_E = 0$
	I_{CEO}	—	—	5	μA	$V_{CE} = 20\text{ V}, R_{BE} = \infty$
DC current transfer ratio	h_{FE}	7000	—	30000		$V_{CE} = 2\text{ V}, I_C = 0.5\text{ A}^{*1}$
	h_{FE}	2000	—	—	—	$V_{CE} = 2\text{ V}, I_C = 2\text{ A}^{*1}$
Collector to emitter saturation voltage	$V_{CE(sat)}$	—	—	1.5	V	$I_C = 2\text{ A}, I_B = 2\text{ mA}^{*1}$
Base to emitter saturation voltage	$V_{BE(sat)}$	—	—	2.0	V	$I_C = 2\text{ A}, I_B = 2\text{ mA}^{*1}$
C to E diode forward voltage	V_D	—	—	2.0	V	$I_D = 2\text{ A}^{*1}$

Note: 1. Pulse test.

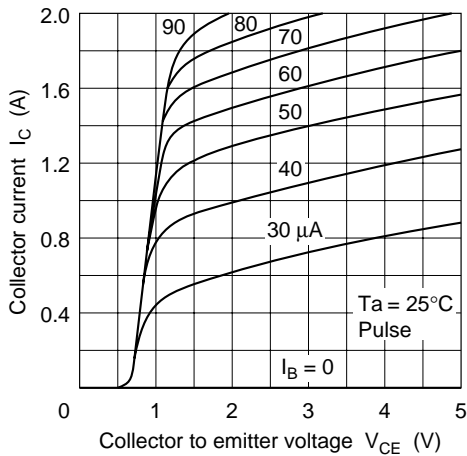
Maximum Collector Dissipation Curve



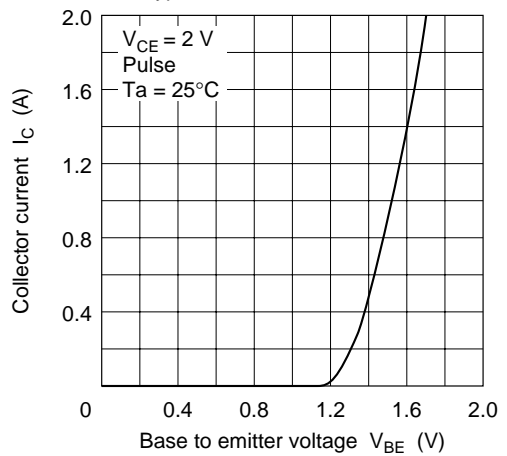
Area of Safe Operation



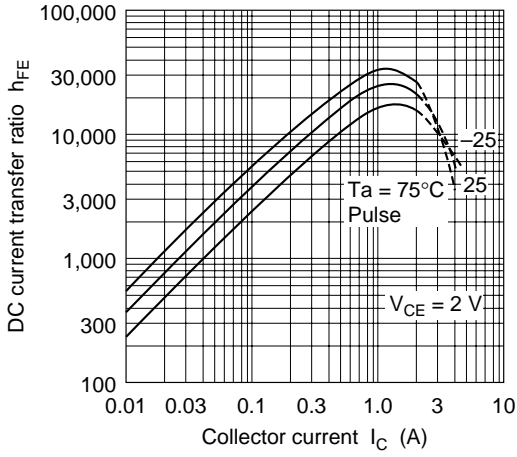
Typical Output Characteristics



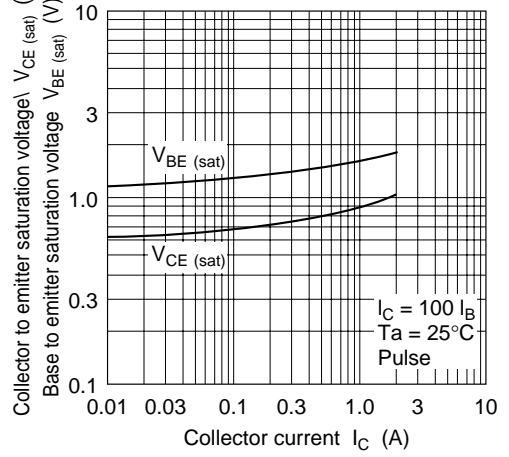
Typical Transfer Characteristics



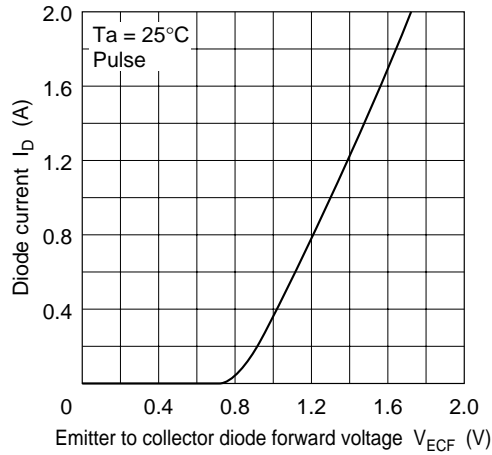
DC Current Transfer Ratio vs. Collector Current

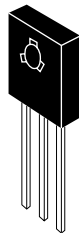
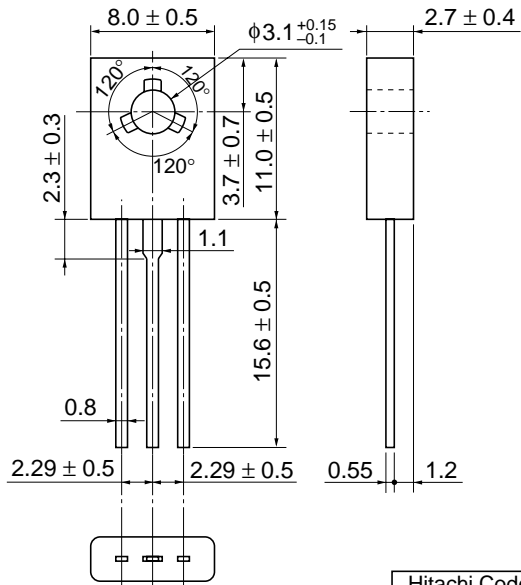


Saturation Voltage vs. Collector Current



Typical Characteristics of Emitter to Collector Diode





Hitachi Code	TO-126 Mod
JEDEC	—
EIAJ	—
Weight (reference value)	0.67 g

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Hitachi, Ltd.

Semiconductor & Integrated Circuits.
Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100-0004, Japan
Tel: Tokyo (03) 3270-2111 Fax: (03) 3270-5109

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For further information write to:

Hitachi Semiconductor
(America) Inc.
179 East Tasman Drive,
San Jose, CA 95134
Tel: <1> (408) 433-1990
Fax: <1> (408) 433-0223

Hitachi Europe GmbH
Electronic components Group
Dornacher Straße 3
D-85622 Feldkirchen, Munich
Germany
Tel: <49> (89) 9 9180-0
Fax: <49> (89) 9 29 30 00

Hitachi Europe Ltd.
Electronic Components Group.
Whitebrook Park
Lower Cookham Road
Maidenhead
Berkshire SL6 8YA, United Kingdom
Tel: <44> (1628) 585000
Fax: <44> (1628) 778322

Hitachi Asia Pte. Ltd.
16 Collyer Quay #20-00
Hitachi Tower
Singapore 049318
Tel: 535-2100
Fax: 535-1533

Hitachi Asia Ltd.
Taipei Branch Office
3F, Hung Kuo Building, No.167,
Tun-Hwa North Road, Taipei (105)
Tel: <886> (2) 2718-3666
Fax: <886> (2) 2718-8180

Hitachi Asia (Hong Kong) Ltd.
Group III (Electronic Components)
7/F., North Tower, World Finance Centre,
Harbour City, Canton Road, Tsim Sha Tsui,
Kowloon, Hong Kong
Tel: <852> (2) 735 9218
Fax: <852> (2) 730 0281
Telex: 40815 HITEC HX

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